

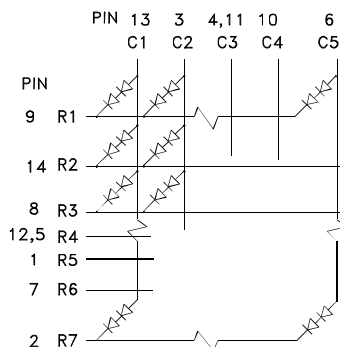
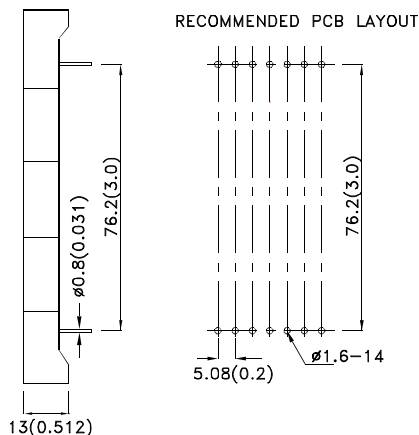
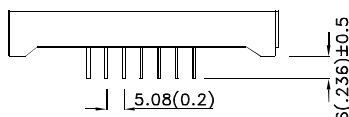
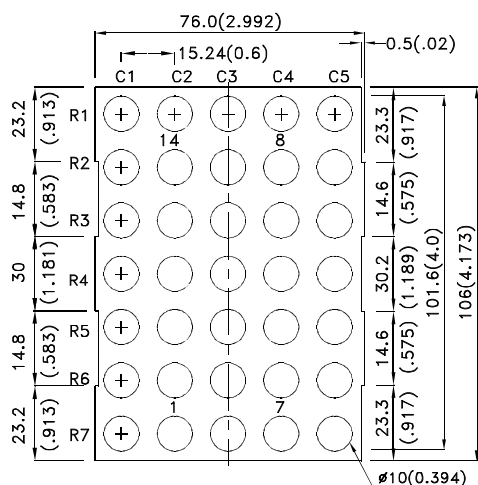
Features

- 4.0 inch matrix height.
- Dot size 10mm.
- Low current operation.
- High contrast and light output.
- Stackable horizontally.
- Easy mounting on p.c. boards or sockets.
- Multicolor available.
- Mechanically rugged.
- Standard : gray face, white dot.
- RoHS compliant.

Description

The Green source color devices are made with Gallium Phosphide Green Light Emitting Diode.

Package Dimensions& Internal Circuit Diagram



Notes:

1. All dimensions are in millimeters (inches), Tolerance is $\pm 0.25(0.01)$ unless otherwise noted.
2. The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.



Selection Guide

Part No.	Dice	Lens Type	Iv (ucd) [1] @ 10mA		Description
			Min.	Typ.	
TA40-11GWA	Green (GaP)	White Diffused	21000	38000	Column Anode
			*9000	*15000	

Notes:

1. Luminous intensity/ luminous Flux: +/-15%.

*Luminous intensity value is traceable to the CIE127-2007 compliant national standards.

Electrical / Optical Characteristics at TA=25°C

Symbol	Parameter	Device	Typ.	Max.	Units	Test Conditions
λ_{peak}	Peak Wavelength	Green	565		nm	I _F =20mA
λ_D [1]	Dominant Wavelength	Green	568		nm	I _F =20mA
$\Delta\lambda_{1/2}$	Spectral Line Half-width	Green	30		nm	I _F =20mA
C	Capacitance (Per Chip)	Green	15		pF	V _F =0V;f=1MHz
V _F [2]	Forward Voltage (Per Dot)	Green	4.4	5.0	V	I _F =20mA
I _R	Reverse Current (Per Dot)	Green		10	uA	V _R =5V

Notes:

1.Wavelength: +/-1nm.

2. Forward Voltage: +/-0.1V.

3. Wavelength value is traceable to the CIE127-2007 compliant national standards.

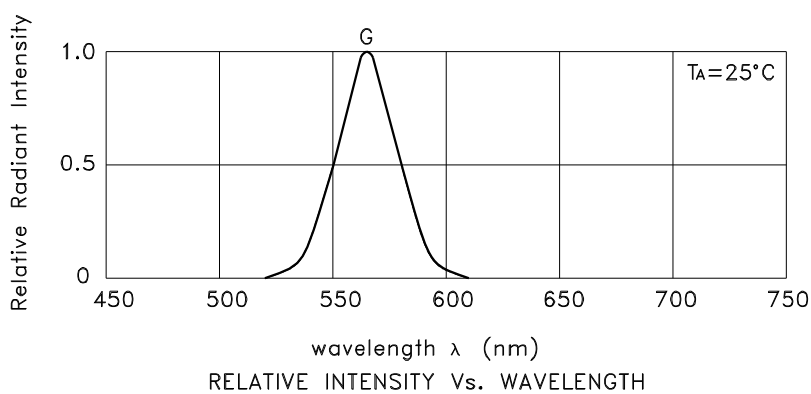
Absolute Maximum Ratings at TA=25°C

Parameter	Green	Units
Power dissipation (Per Dot)	125	mW
DC Forward Current (Per Dot)	25	mA
Peak Forward Current [1] (Per Dot)	140	mA
Reverse Voltage (Per Dot)	5	V
Operating / Storage Temperature	-40°C To +85°C	
Lead Solder Temperature[2]	260°C For 3-5 Seconds	

Notes:

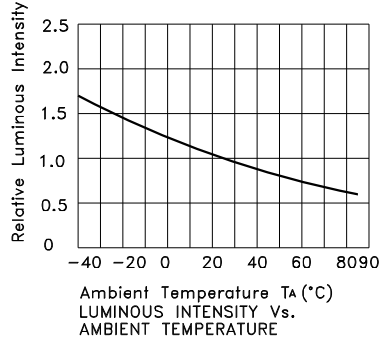
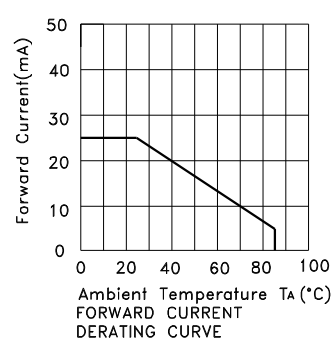
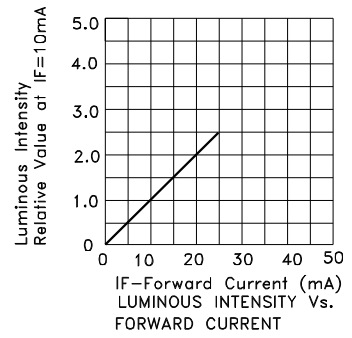
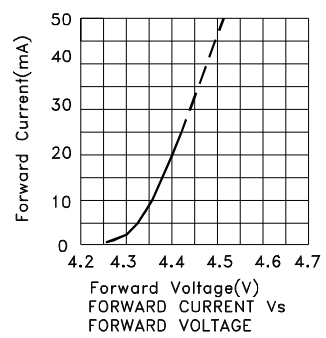
1. 1/10 Duty Cycle, 0.1ms Pulse Width.

2. 2mm below package base.



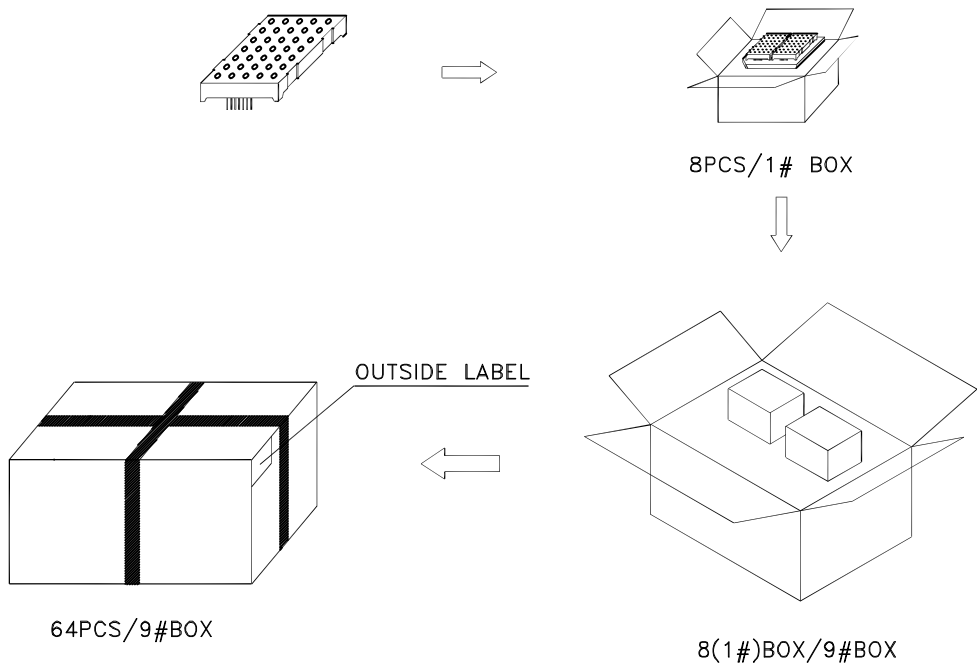
Green

TA40-11GWA



PACKING & LABEL SPECIFICATIONS

TA40-11GWA



Inside LABEL On 1#BOX

Kingbright	TYPE: TX40-11XXX	PASSED xx xx xx FQCX	Date
	QTY: 8 PCS CODE: xx		
			
XXXXXXXXXX-XXXX		Number OF FQC	
LOT NO.		RoHS Compliant	

Outside LABEL On Box

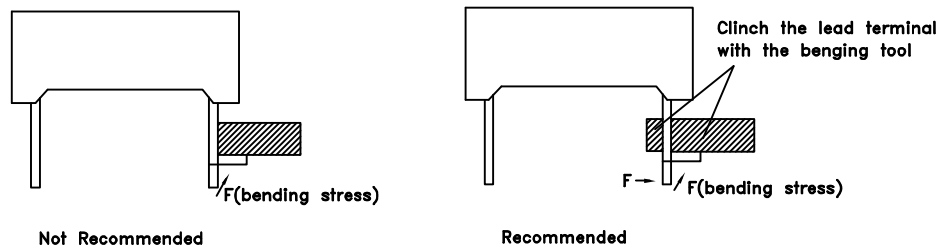
XXXXXX		
TX40-11XXX	Bin Code	Number OF QA
64 PCS	XX	
	QAxx xx xx xx PASSED	Date
	RoHS Compliant	

THROUGH HOLE DISPLAY MOUNTING METHOD

Lead Forming

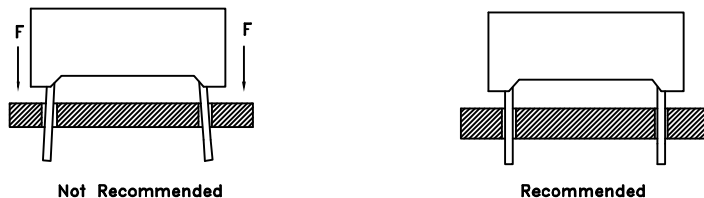
Do not bend the component leads by hand without proper tools.

The leads should be bent by clinching the upper part of the lead firmly such that the bending force is not exerted on the plastic body.

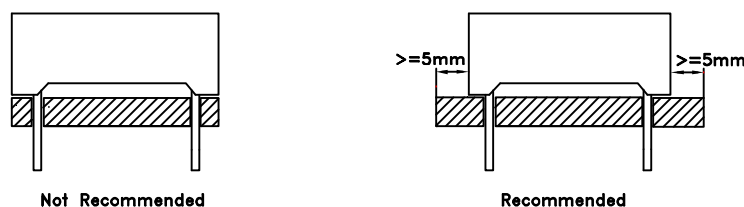


Installation

- 1.The installation process should not apply stress to the lead terminals.
- 2.When inserting for assembly, ensure the terminal pitch matches the substrate board's hole pitch to prevent spreading or pinching the lead terminals.

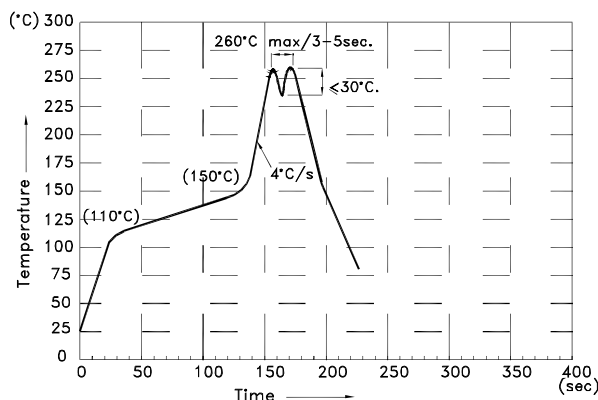


- 3.The component shall be placed at least 5mm from edge of PCB to avoid damage caused excessive heat during wave soldering.



DISPLAY SOLDERING CONDITIONS

Wave Soldering Profile For Lead-free Through-hole LED.



NOTES:

1. Recommend the wave temperature $245^{\circ}\text{C} \sim 260^{\circ}\text{C}$. The maximum soldering temperature should be less than 260°C .
2. Do not apply stress on epoxy resins when temperature is over 85°C .
3. The soldering profile apply to the lead free soldering (Sn/Cu/Ag alloy).
4. During wave soldering, the PCB top-surface temperature should be kept below 105°C .
5. No more than once.

Soldering General Notes:

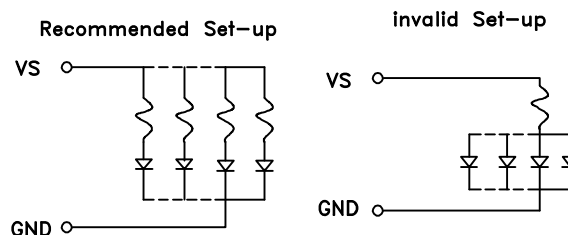
1. Through-hole displays are incompatible with reflow soldering.
2. If components will undergo multiple soldering processes, or other processes where the components may be subjected to intense heat, please check with Kingbright for compatibility.

CLEANING

1. Mild "no-clean" fluxes are recommended for use in soldering.
2. If cleaning is required, Kingbright recommends to wash components with water only. Do not use harsh organic solvents for cleaning, because they may damage the plastic parts. And the devices should not be washed for more than one minute.

CIRCUIT DESIGN NOTES

1. Protective current-limiting resistors may be necessary to operate the Displays.
2. LEDs mounted in parallel should each be placed in series with its own current-limiting resistor.



Detailed application notes are listed on our website.
http://www.kingbright.com/application_notes